

DCC ISSUE		REV	MODIFICATION	DATE	DRAW	APPROVE
		J	EN1203039	13-MAR-12	SINGYOU	STAN
		K	EN1210036	16-OCT-12	ELIC	C.Y
		L	EN1303038	12-MAR-13	DANIEL	C.Y

Notes:

1. Material:

Contact: High Performance Copper Alloy
 Shielding Cover: High Performance Copper Alloy
 Housing: High Temperature Theroplastic.

2. Finish:

Contact: 50u" Nickel Underplating Overall. Gold Flash(2~3u") on Contact Area & Solder tail.
 Shielding Cover: 50u" Nickel Underplating Overall. Gold Plating See Order Information.

3. Halogen-Free Product P/N:

C90P103-1 X00XAH

Contact: Shielding Cover Plating:
 Fork Type 4: Gold Flash on contact area & solder tail.
 5: Nickel plated on contact area. Gold flash on solder tail.

△ Package:
 0: Carrier Tape W=8mm, Pitch=4mm. (PKG. SPEC. AAA-C90-0301)
 1: Carrier Tape W=12mm, Pitch=8mm. (PKG. SPEC. AAA-C90-0302)

△ 說明:

1. 材料:

訊號端子: 高性能銅合金
 鐵殼: 高性能銅合金
 塑膠: 高溫熱塑性塑膠

2. 電鍍:

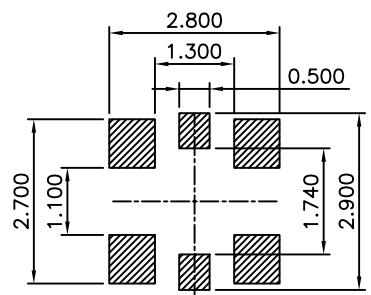
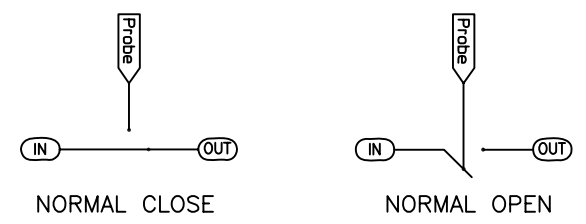
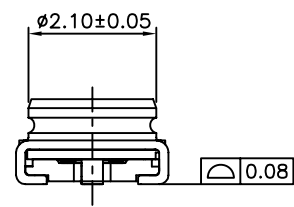
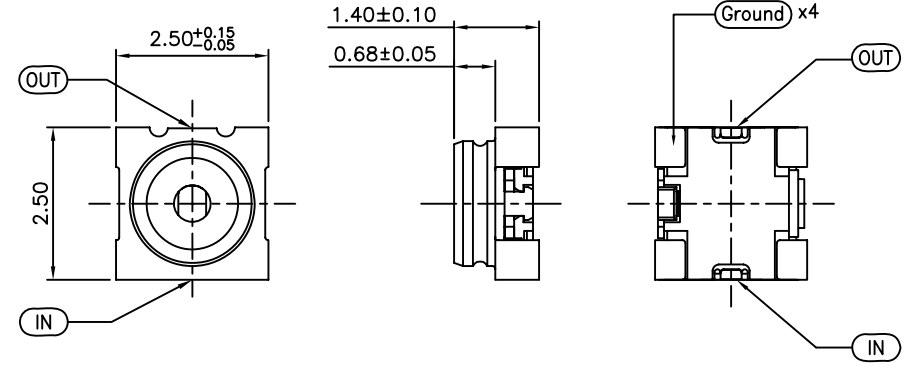
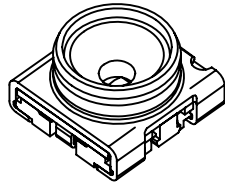
訊號端子: 50u"鍍底, 接觸區域與焊錫區域刷金(2~3u")
 鐵殼: 50u"鍍底, 接觸區域與焊錫區域依訂單需求選擇電鍍方式。

3. 無鹵料號:

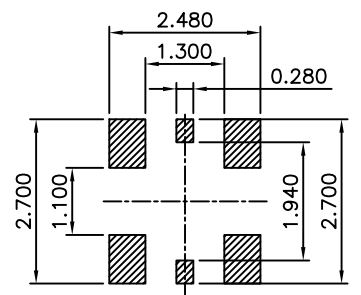
C90P103-1 X00XAH

訊號端子: 有魚叉
 鐵殼電鍍: 4: 接觸區域與焊錫區域鍍金。
 5: 接觸區域鍍鎳, 焊錫區域鍍金。

包裝:
 0: 載帶 寬度=8mm, Pitch=4mm. (包裝規範 AAA-C90-0301)
 1: 載帶 寬度=12mm, Pitch=8mm. (包裝規範 AAA-C90-0302)



Recommend PCB Layout



Recommend Stencil Mask Pattern (Mask Thickness 0.08mm)

DIMENSION IN mm [Inch]		PROD. SPEC.			
TOLERANCE UNLESS OTHERWISE SPECIFIED					
.X±0.25	X.*± 5°	PKG. SPEC.	FILE NO.	DWG NO.	C-C90-103-4
.XX±0.10	.X.*± 3°				
.XXX±0.06	.XX.*±				
TITLE RF Switch Connector				CUSTOMER DRAWING	
APPROVE	CHECK	DRAW	PROJ.	SHEET 1 / 1	
C.Y	STAN	DANIEL	SCALE 8:1	SIZE A4	REV L

© 2004/08/04 BY SPEED TECH CORP. ALL RIGHTS RESERVED. PRODUCTS ARE COVERED BY PATENTS AND/OR PATENTS PENDING.

单击下面可查看定价，库存，交付和生命周期等信息

[>>SpeedTech](#)